Raspberry PI Heat Sink Kit multicomp



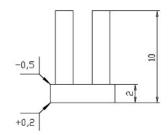


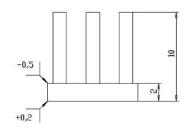


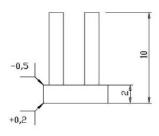


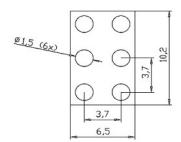
The Farnell Raspberry PI heat sink kit will ensure your Raspberry PI remains cool with no need for Fans. They will also help extend the life of your Raspberry PI and thereby reduce hardware failures.

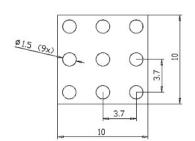
The heat sink kit comprises of 3 high quality Pressfin heat sinks which are designed to fit the 3 main heat sources on the Raspberry PI. Included in the kit is a 50mm × 50mm piece of thermal adhesive tape to securely fix the heat sinks in place and to ensure a good thermal transfer bond.

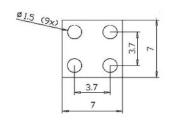












Dimensions: Millimetres

Part Number Table

Description	Part Number
Raspberry PI Heat Sink Kit	2319947

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